IFW



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Tsuyoshi KANEKO Group Art Unit: 2826

Application No.: 10/849,884 Examiner: B. SANDVIK

Filed: May 21, 2004 Docket No.: 119593

For: BUMP STRUCTURE AND METHOD OF MANUFACTURING THE SAME, AND

MOUNTING STRUCTURE FOR IC CHIP AND CIRCUIT BOARD

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In reply to the July 27, 2005 Office Action, please consider the following:

Amendments to the Claims as reflected in the listing of claims; and

Remarks.